



Click [here](#) for the 3D model.

General Information

| | |
|-------------|--------------------------------|
| Series | CQ |
| Style | SMD Chip |
| Features | Ultra High Q, Low ESR, Class I |
| RoHS | Yes |
| Termination | Tin |

| Dimensions | |
|----------------------|------------------|
| L | 2mm +/-0.2mm |
| W | 1.25mm +/-0.2mm |
| T | 0.6mm +/-0.1mm |
| B | 0.5mm +/-0.250mm |
| Case Code (EIA / mm) | 0805 / 2012 |

| Packaging Specifications | |
|--------------------------|------------------------|
| Packaging | T&R, 178mm, Paper Tape |
| Packaging Quantity | 4000 |

| Specifications | |
|-----------------------|------------|
| Capacitance | 10 pF |
| Tolerance | 1% |
| Voltage DC | 250 VDC |
| Temperature Range | -55/+125°C |
| Temp. Coefficient | COG |
| Dissipation Factor | 0.17% |
| Insulation Resistance | 10 GOhms |

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